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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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High Voltage Standard Rectifier Module

= 2x 2200 V

310 A

 V_{F} 1.03 V

Phase leg

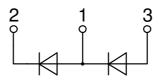
Part number

MDD312-22N1



Backside: isolated





Features / Advantages:

- Package with DCB ceramic
- Improved temperature and power cycling
- Planar passivated chips
- Very low forward voltage drop
- Very low leakage current

Applications:

- Diode for main rectification
- For single and three phase bridge configurations
- Supplies for DC power equipment
- Input rectifiers for PWM inverter
- Battery DC power supplies
- Field supply for DC motors

Package: Y1

- Isolation Voltage: 3600 V~
- Industry standard outline
- RoHS compliant
- Base plate: Copper internally DCB isolated
- Advanced power cycling

Terms _Conditions of usage:

The data contained in this product data sheet is exclusively intended for technically trained staff. The user will have to evaluate the suitability of the product for the intended application and the completeness of the product data with respect to his application. The specifications of our components may not be considered as an assurance of component characteristics. The information in the valid application- and assembly notes must be considered. Should you require product information in excess of the data given in this product data sheet or which concerns the specific application of your product, please contact your local sales office.

Due to technical requirements our product may contain dangerous substances. For information on the types in question please contact your local sales office.

Should you intend to use the product in aviation, in health or life endangering or life support applications, please notify. For any such application we urgently recommend

to perform joint risk and quality assessments;
the conclusion of quality agreements;

- to establish joint measures of an ongoing product survey, and that we may make delivery dependent on the realization of any such measures.

IXYS reserves the right to change limits, conditions and dimensions.

Data according to IEC 60747 and per semiconductor unless otherwise specified

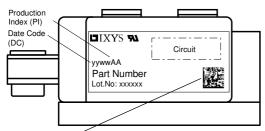




Rectifier			Ratings				
Symbol	Definition	Conditions		min.	typ.	max.	Unit
V _{RSM}	max. non-repetitive reverse bloc	king voltage	$T_{VJ} = 25^{\circ}C$			2300	V
V _{RRM}	max. repetitive reverse blocking	voltage	$T_{VJ} = 25^{\circ}C$			2200	V
I _R	reverse current	V _R = 2200 V	$T_{VJ} = 25^{\circ}C$			500	μΑ
		$V_R = 2200 \text{ V}$	$T_{VJ} = 150$ °C			30	mΑ
V _F	forward voltage drop	I _F = 300 A	$T_{VJ} = 25^{\circ}C$			1.13	V
		$I_F = 600 A$				1.33	V
		I _F = 300 A	$T_{VJ} = 125$ °C			1.03	٧
		$I_F = 600 A$				1.29	٧
I FAV	average forward current	T _C = 100°C	T _{vJ} = 150°C			310	Α
I _{F(RMS)}	RMS forward current	180° sine $d = 0.5$				520	Α
V _{F0}	threshold voltage		T _{vJ} = 150°C			0.80	٧
r _F	slope resistance } for power	loss calculation only				0.6	mΩ
R _{thJC}	thermal resistance junction to ca	ase				0.12	K/W
R _{thCH}	thermal resistance case to heats	sink			0.04		K/W
P _{tot}	total power dissipation		$T_{C} = 25^{\circ}C$			1040	W
I _{FSM}	max. forward surge current	t = 10 ms; (50 Hz), sine	$T_{VJ} = 45^{\circ}C$			10.8	kA
		t = 8,3 ms; (60 Hz), sine	$V_R = 0 V$			11.7	kA
		t = 10 ms; (50 Hz), sine	T _{vJ} = 150°C			9.18	kA
		t = 8,3 ms; (60 Hz), sine	$V_R = 0 V$			9.92	kA
l²t	value for fusing	t = 10 ms; (50 Hz), sine	$T_{VJ} = 45^{\circ}C$			583.2	kA2s
		t = 8,3 ms; (60 Hz), sine	$V_R = 0 V$			566.1	kA2s
		t = 10 ms; (50 Hz), sine	T _{vJ} = 150°C			421.4	kA2s
		t = 8,3 ms; (60 Hz), sine	$V_R = 0 V$			409.0	kA2s
C¹	junction capacitance	$V_R = 700 \text{ V}; f = 1 \text{ MHz}$	$T_{VJ} = 25^{\circ}C$		288		pF



Package Y1			Ratings				
Symbol	Definition	Conditions		min.	typ.	max.	Unit
I _{RMS}	RMS current	per terminal				600	Α
T _{VJ}	virtual junction temperature			-40		150	°C
T _{op}	operation temperature			-40		125	°C
T _{stg}	storage temperature			-40		125	°C
Weight					680		g
M _D	mounting torque			4.5		7	Nm
$\mathbf{M}_{\scriptscriptstyleT}$	terminal torque			11		13	Nm
d _{Spp/App}	creepage distance on surface str	riking diatanaa thraugh air	terminal to terminal	16.0			mm
d _{Spb/Apb}	creepage distance on surface str	iking distance through an	terminal to backside	16.0			mm
V _{ISOL}	isolation voltage	t = 1 second		3600			٧
1002		$t = 1 \text{ minute}$ 50/60 Hz, RMS; IsoL $\leq 1 \text{ mA}$		3000			٧



Data Matrix: part no. (1-19), DC + PI (20-25), lot.no.# (26-31), blank (32), serial no.# (33-36)

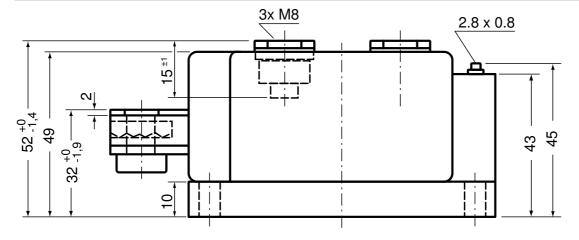
Ordering	Ordering Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	MDD312-22N1	MDD312-22N1	Box	3	467278

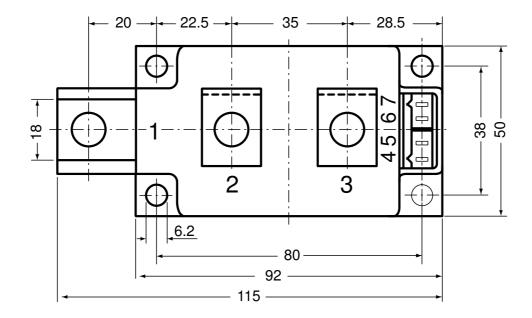
Similar Part	Package	Voltage class
MDD312-12N1	Y1-CU	1200
MDD312-14N1	Y1-CU	1400
MDD312-16N1	Y1-CU	1600
MDD312-18N1	Y1-CU	1800
MDD312-20N1	Y1-CU	2000

Equivalent Circuits for Simulation		* on die level	$T_{VJ} = 150 ^{\circ}\text{C}$	
$I \rightarrow V_0$)—[R_o]-	Rectifier		
V _{0 max}	threshold voltage	8.0		V
R_{0max}	slope resistance *	0.4		$m\Omega$



Outlines Y1

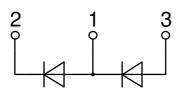




Optional accessories for modules

. Keyed gate/cathode twin plugs with wire length = 350 mm, gate = white, cathode = red

Type ZY 180L (L = Left for pin pair 4/5) Type ZY 180R (R = Right for pin pair 6/7) UL 758, style 3751





Rectifier

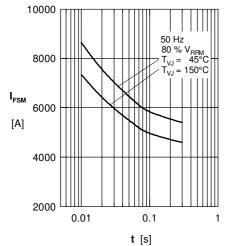


Fig. 1 Surge overload current I_{FSM}: Crest value, t: duration

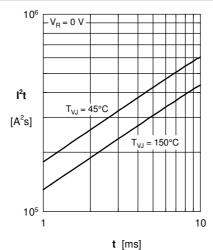


Fig. 2 I²t versus time (1-10 ms)

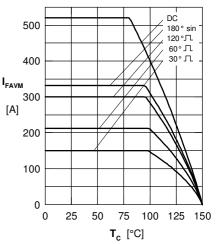


Fig. 3 Maximum forward current at case temperature

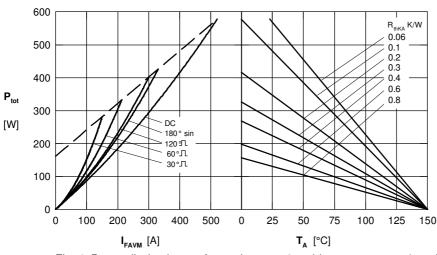


Fig. 4 Power dissipation vs. forward current & ambient temperature (per diode)

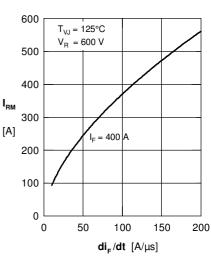


Fig. 5 Typ. peak reverse current

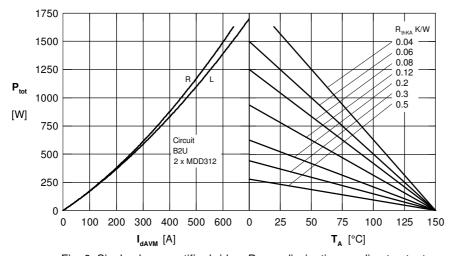


Fig. 6 Single phase rectifier bridge: Power dissipation vs. direct output current and ambient temperature R = resistive load, L = inductive load

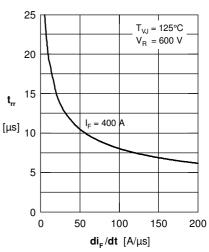


Fig. 7 Typ. recovery time t_{rr} versus $-di_{\rm F}/dt$



Rectifier

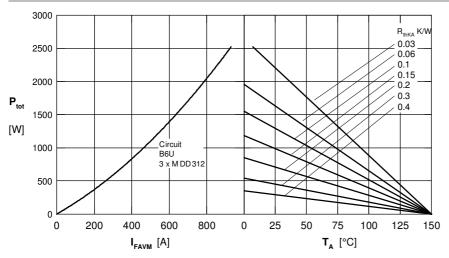


Fig. 8 Three phase rectifier bridge: Power dissipation vs. direct output current & ambient temperature

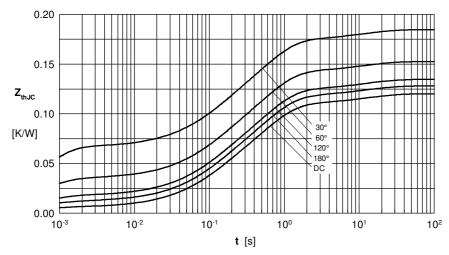


Fig. 9 Transient thermal impedance junction to case (per diode)

 R_{thJC} for various conduction angles d

d	R _{thJC} [K/W
DC	0.120
180°	0.128
120°	0.135
60°	0.153
30°	0.185

Constants for Z_{thJC} calculation:

i	R_{thi} (K/W)	t _i (s)
1	0.0058	0.00054
2	0.0310	0.09800
3	0.0720	0.54000
1	0.0112	12 0000

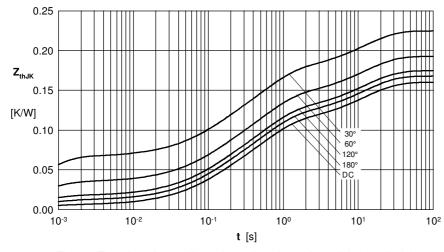


Fig. 10 Transient thermal impedance junction to heatsink (per diode)

 $\boldsymbol{R}_{\text{thJK}}$ for various conduction angles d

d	R_{thJK} [K/W]
DC	0.160
180°	0.168
120°	0.175
60°	0.193
30°	0.225

Constants for Z_{thJK} calculation:

i	R_{thi} (K/W)	t _i (s)
1	0.0058	0.00054
2	0.0310	0.09800
3	0.0720	0.54000
4	0.0112	12.0000
5	0.0400	12 0000